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# Contact us

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Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

## TC74VHC165F,TC74VHC165FN,TC74VHC165FT,TC74VHC165FK

8-Bit Shift Register (P-IN, S-OUT)

The TC74VHC165 is an advanced high speed CMOS 8-BIT PARALLEL/SERIAL-IN, SERIAL-OUT SHIFT REGISTER fabricated with silicon gate C<sup>2</sup>MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

It consists of parallel-in or serial-in, serial-out 8-bit shift register with a gated clock input. When the SHIFT/ $\overline{\text{LOAD}}$  input is held high, the serial data input is enabled and the eight frip-frops perform serial shifting with each clock pulse.

When the SHIFT/LOAD input is held low, the parallel data is loaded synchronously into the register at positive going transition of the clock pulse.

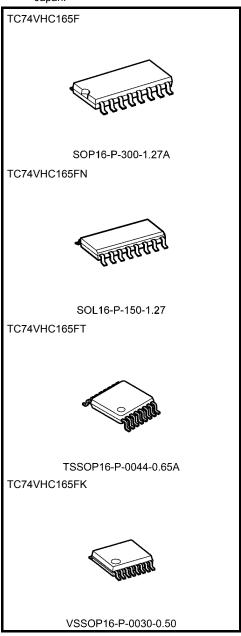
The CK-INH input should be shifted high only when the CK input is held high.

An Input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and on two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

#### **Features**

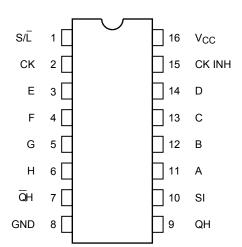
- High speed:  $f_{max} = 150 \text{ MHz}$  (typ.) at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu A \text{ (max)}$  at  $T_{a} = 25 \text{°C}$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$  (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays:  $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range:  $V_{CC}$  (opr) = 2 V to 5.5 V
- Pin and function compatible with 74ALS165

Note: xxxFN (JEDEC SOP) is not available in Japan.

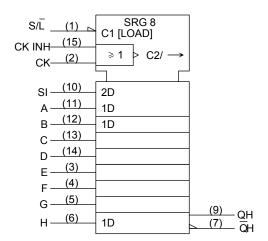


Weight SOP16-P-300-1.27A: 0.18 g (typ.) SOL16-P-150-1.27: 0.13 g (typ.) TSSOP16-P-0044-0.65A: 0.06 g (typ.) VSSOP16-P-0030-0.50: 0.02 g (typ.)

### **Pin Assignment**



## **IEC Logic Symbol**



### **Truth Table**

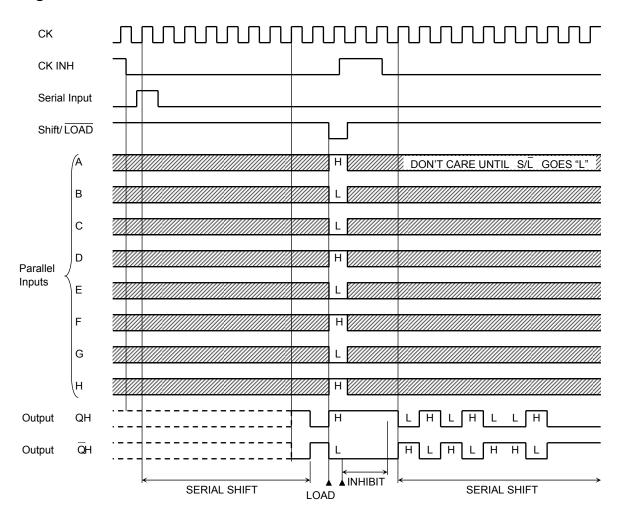
Inputs					Internal Outputs		Outputs		
SHIFT/ LOAD	CK INH	СК	SERIAL IN	PARALLEL A······H	QA	QA QB		QH	
L	Х	Х	Х	a·····h	а	b	h	h	
Н	L	$\Box$	Н	Х	Н	QAn	QGn	$\overline{Q}G_n$	
Н	L		L	Х	L	QAn	QGn	$\overline{Q}G_n$	
Н		L	Н	Х	Н	QAn	QGn	$\overline{Q}G_n$	
Н		L	L	Х	L	QAn	QGn	$\overline{Q}G_n$	
Н	Х	Н	Х	Х	No Change				
Н	Н	Х	Х	Х	No Change				

X: Don't care

a·····h: The level of steady state input voltage at inputs A through H respectively

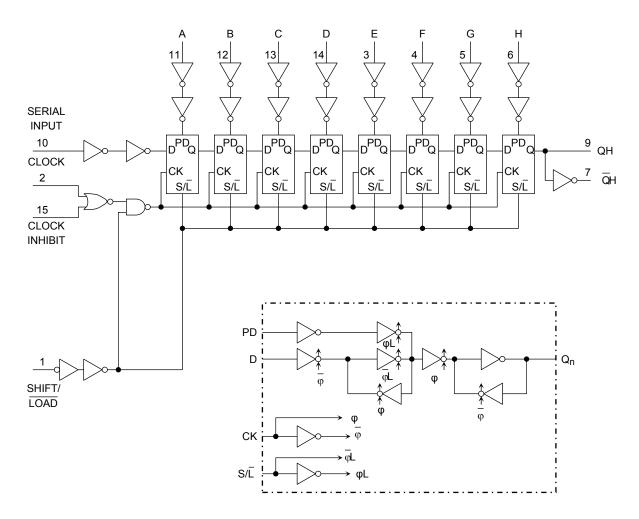
QA<sub>n</sub> to QG<sub>n</sub>: The level of QA to QG, respectively, before the most recent positive transition of the CK.

## **Timing Chart**



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#### **System Diagram**



### **Absolute Maximum Ratings (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	−0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	-0.5 to 7.0	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	lık	-20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	Icc	±50	mA
Power dissipation	P <sub>D</sub>	180	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



## **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit	
Supply voltage	$V_{CC}$	2.0 to 5.5	V	
Input voltage	V <sub>IN</sub>	0 to 5.5	V	
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 100 (V <sub>CC</sub> = $3.3 \pm 0.3$ V)	ns/V	
input rise and rail time	ui/uv	0 to 20 (V <sub>CC</sub> = $5 \pm 0.5$ V)		

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition V <sub>CC</sub> (V)		Ta = 25°C			Ta = -40 to 85°C		- Unit	
Sharastonesis	Cymbol .				Min	Тур.	Max	Min	Max	
High-level input voltage	V <sub>IH</sub>	_		2.0 3.0 to 5.5	1.50 V <sub>CC</sub> × 0.7			1.50 V <sub>CC</sub> × 0.7		V
Low-level input voltage	V <sub>IL</sub>	_		2.0 3.0 to 5.5		_ _	0.50 V <sub>CC</sub> × 0.3	_ _	0.50 V <sub>CC</sub> × 0.3	V
High-level output voltage	V <sub>ОН</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	$I_{OH} = -50 \mu A$ $I_{OH} = -4 \text{ mA}$	2.0 3.0 4.5	1.9 2.9 4.4 2.58	2.0 3.0 4.5	_ _ _	1.9 2.9 4.4 2.48	_ _ _	V
			$I_{OH} = -4 \text{ mA}$	4.5	3.94	_	_	3.80	_	
Low-level output voltage	V <sub>OL</sub>	V <sub>OL</sub> V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	Ι <sub>ΟL</sub> = 50 μΑ	2.0 3.0 4.5	_ _ _	0.0 0.0 0.0	0.1 0.1 0.1	_ _ _	0.1 0.1 0.1	V
			$I_{OL} = 4 \text{ mA}$ $I_{OL} = 8 \text{ mA}$	3.0 4.5	_ _	_ _	0.36 0.36	_	0.44 0.44	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5	_	_	±0.1	_	±1.0	μΑ
Quiescent supply current	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	4.0	_	40.0	μΑ

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# Timing Requirements (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition	Test Condition			Unit	
		7	V <sub>CC</sub> (V)	Limit	Limit		
Minimum pulse width	t <sub>w (L)</sub>		$3.3 \pm 0.3$	6.0	7.0		
(CK, CK INH)	t <sub>w (H)</sub>	_	$5.0 \pm 0.5$	4.0	4.0	ns	
Minimum pulse width			$3.3\pm0.3$	7.5	9.0		
(S/L)	t <sub>w (L)</sub>	_	$5.0 \pm 0.5$	5.0	6.0	ns	
Minimum set-up time	4		$3.3 \pm 0.3$	7.5	8.5		
(PI- S/L )	t <sub>s</sub>	_	$5.0 \pm 0.5$	5.0	5.0	ns	
Minimum set-up time			$3.3\pm0.3$	5.0	6.0		
(SI-CK, CK INH)	t <sub>s</sub>	_	$5.0 \pm 0.5$	4.0	4.0	ns	
Minimum set-up time			$3.3\pm0.3$	5.0	6.0		
(S/L-CK, CK INH)	t <sub>S</sub>	_	$5.0 \pm 0.5$	4.0	4.0	ns	
Minimum hold time			$3.3 \pm 0.3$	0.5	0.5		
(PI- S/L )	t <sub>h</sub>	_	$5.0 \pm 0.5$	1.0	1.0	ns	
Minimum hold time			$3.3 \pm 0.3$	0.0	0.0		
(SI-CK, CK INH)	t <sub>h</sub>	_	$5.0 \pm 0.5$	0.5	0.5	ns	
Minimum hold time	+.		$3.3 \pm 0.3$	0.0	0.0	no	
(S/L-CK, CK INH)	t <sub>h</sub>	_	$5.0 \pm 0.5$	0.5	0.5	ns	
Minimum removal time			3.3 ± 0.3	5.0	5.0		
(CK INH-CK)	t <sub>rem</sub>	_	$5.0 \pm 0.5$	3.5	3.5	ns	
(CK-CK INH)			5.0 ± 0.5	3.5	3.5		



AC Characteristics (input:  $t_r = t_f = 3$  ns)

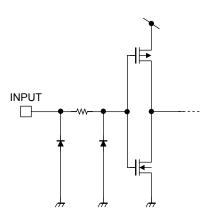
Characteristics	Symbol	Test Condition	Test Condition		Ta = 25°C			Ta = -40 to 85°C	
	,	V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	
		3.3 ± 0.3	15	_	9.9	15.4	1.0	18.0	
Propagation delay time	$t_{pLH}$	3.3 ± 0.3	50	_	12.4	18.9	1.0	21.5	200
(CK, CK INH-QH, QH)	$t_{pHL}$	5.0 ± 0.5	15	_	6.6	9.9	1.0	11.5	ns
		5.0 ± 0.5	50	_	8.1	11.9	1.0	13.5	
		3.3 ± 0.3	15	_	9.9	15.8	1.0	18.5	
Propagation delay time	$t_{pLH}$	3.3 ± 0.3	50	_	12.4	19.3	1.0	22.0	
(S/L-QH, QH)	$t_{pHL}$	5.0 ± 0.5	15	_	6.7	9.9	1.0	11.5	ns
		3.0 ± 0.5	50	_	8.2	11.9	1.0	13.5	
		3.3 ± 0.3	15	_	9.2	14.1	1.0	16.5	
Propagation delay time	$t_{pLH}$	3.3 ± 0.3	50	_	11.7	17.6	1.0	20.0	ns
(H-QH, $\overline{Q}H$ )	$t_{pHL}$	5.0 ± 0.5	15	_	5.9	9.0	1.0	10.5	115
		3.0 ± 0.5	50	_	7.4	11.0	1.0	12.5	
		3.3 ± 0.3	15	65	85	_	55	_	
Maximum clock frequency	f <sub>max</sub> —	3.3 ± 0.3	50	60	105	_	50	_	- MHz
Maximum clock frequency		5.0 ± 0.5	15	110	150	_	90	_	
		3.0 ± 0.5	50	95	130	_	85	_	
Input capacitance	C <sub>IN</sub>	_		_	4	10	_	10	pF
Power dissipation capacitance	C <sub>PD</sub>		(Note)	_	50	_	_	_	pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

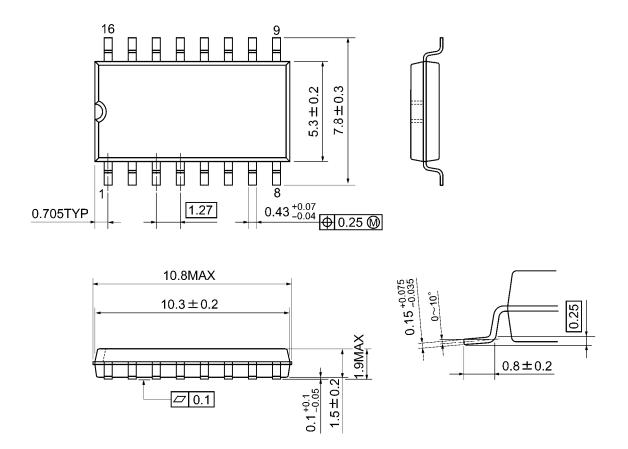
$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$$

### **Input Equivalent Circuit**



## **Package Dimensions**

SOP16-P-300-1.27A Unit: mm

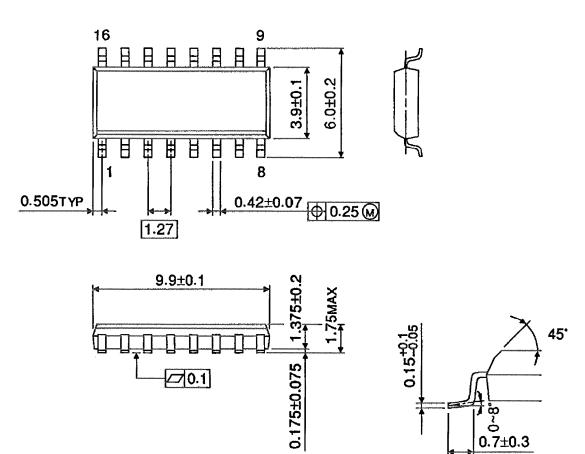


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Weight: 0.18 g (typ.)

## **Package Dimensions (Note)**

SOL16-P-150-1.27 Unit: mm



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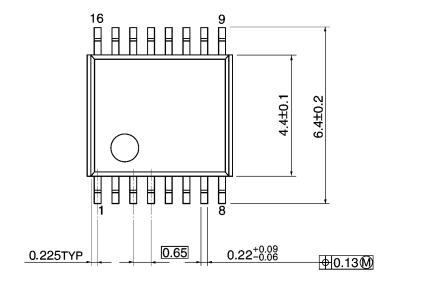
Note: This package is not available in Japan.

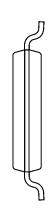
Weight: 0.13 g (typ.)

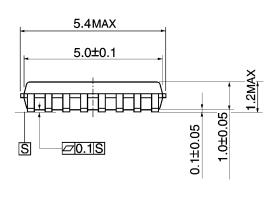
## **Package Dimensions**

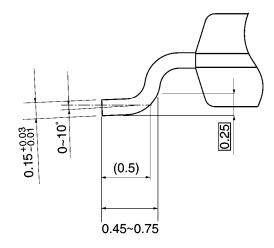
TSSOP16-P-0044-0.65A

Unit: mm





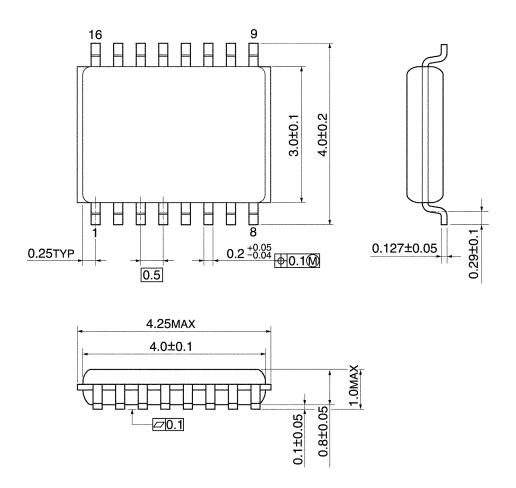




Weight: 0.06 g (typ.)

## **Package Dimensions**

VSSOP16-P-0030-0.50 Unit: mm



Weight: 0.02 g (typ.)

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